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TFT | CHARACTER | UWVD | FSC | SEGMENT | CUSTOM | REPLACEMENT

TFT Display Module

Part Number E70RA-FW450-C

Overview:

- 7.0-inch TFT (165x100mm)
- 6/8-bit LVDS Interface
- 1024(RGB)x600 pixels
- Wide Temperature
- White LED back-light

- Transmissive/ Normally Black
- Capacitive Touch Screen
- 450 NITS
- Controller: EK73215/EK79001
- RoHS Compliant



Description

This is a color active matrix TFT (Thin Film Transistor) LCD (Liquid Crystal Display) that uses amorphous silicon TFT as a switching device. This model is composed of a transmissive type TFT-LCD Panel, driver circuit, capacitive touch panel and a backlight unit. The resolution of the 7.0" TFT-LCD contains 1024(RGB)x600 pixels and can display up to 16.7M colors.

TFT Features

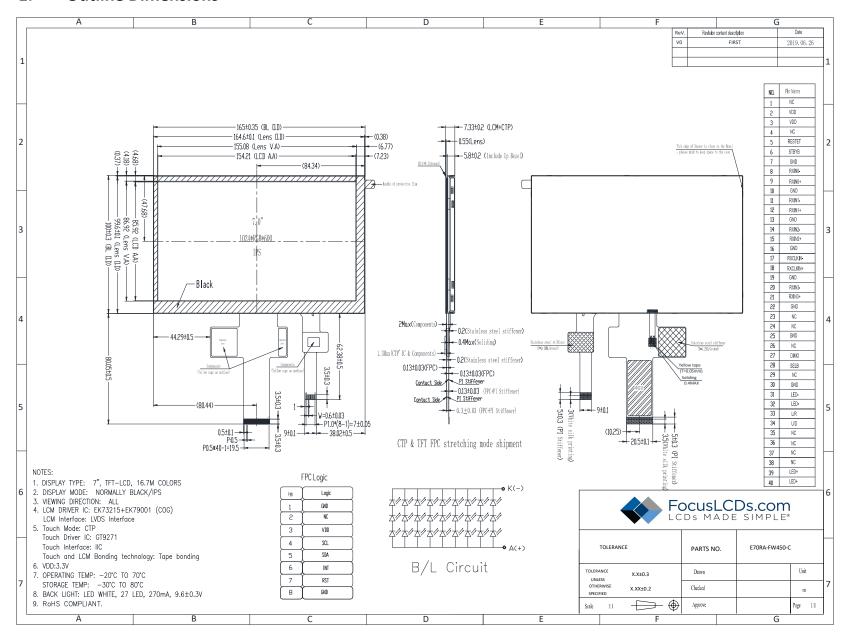
Display Colors: 16.7M Interface: 6/8 bit LVDS Touch Panel: Capacitive

General Information Items	Specification Main Panel	Unit	Note
TFT Display area (AA)	154.21(H) x 85.92 (7.0 inch)	mm	-
Driver Element	TFT active matrix	-	-
Display Colors	16.7M	colors	-
Number of pixels	1024(RGB)x600	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel Pitch	0.1506 (H)x0.1432(V)	mm	-
Viewing angle	ALL	o'clock	-
TFT Controller IC	EK73215/EK79001	-	-
CTP Driver IC	GT9271	-	-
TFT Interface	6/8 bit LVDS	-	-
CTP Interface	I2C	-	-
CTP Structure	G+G	-	-
CTP Slave Address	0x5D(7bit) or 0x14(7bit)	-	-
Touch Mode	10 Points and Gestures	-	-
Display mode	Transmissive/ Normally Black	-	-
Operating temperature	-20~+70	°C	
Storage temperature	-30~+80	°C	-

Mechanical Information

	Item	Min	Тур.	Max	Unit	Note
	Horizontal (H)		165		mm	-
Module	Vertical (V)		100		mm	-
Size	Depth (D)		7.33		mm	-
	Weight				g	

1. Outline Dimensions

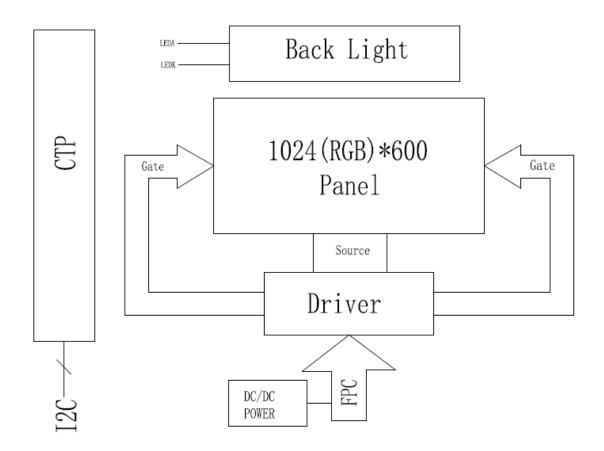


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2. Block Diagram





3. Input Terminal Pin Assignment

Recommended TFT Connector: FH12S-40S-0.5SH(55) | Recommended CTP Connector: FH12-8S-0.5SH(55)

NO.	Symbol	Description	1/0
1	NC	Not connected	
2	VDD	Digital newer cumby	Р
3	VDD	Digital power supply	r
4	NC	Not connected	
5	RESET	Reset signal of the device. Active low.	1
6	STBYB	Standby mode. Pulled high. STBYB=1, normal operation mode. STBYB=0, timing controller with source driver off. The output is High-Z.	1
7	GND	Ground	Р
8	RXIN0-	- LVDS differential data input	1
9	RXIN0+	+ LVDS differential data input	ı
10	GND	Ground	Р
11	RXIN1-	- LVDS differential data input	ı
12	RXIN1+	+ LVDS differential data input	I
13	GND	Ground	Р
14	RXIN2-	- LVDS differential data input	I
15	RXIN2+	+ LVDS differential data input	I
16	GND	Ground	Р
17	RXCLKN-	- LVDS differential clock input	ı
18	RXCLKN+	+ LVDS differential clock input	I
19	GND	Ground	Р
20	RXIN3-	- LVDS differential data input	I
21	RXIN3+	+ LVDS differential data input	I
22	GND	Ground	Р
23-24	NC	Not connected	
25	GND	Ground	Р
26	DIMO	Backlight dimmer for external controller. DIMO=0, turn off external backlight controller. DIMO=1, logic control signal to turn on external backlight controller. If CABC off, DIMO=DIMI. Else DIMO is controlled by CABC.	0
27	SELB	Input data format selection. SELB=0, 8-bit LVDS. SELB=1, 6-bit LVDS	1
28	NC	Not connected	
29	GND	Ground	Р
30	LED-	LED cathode pin of the backlight	Р
31	LED-	LED cathode pin of the backlight	Р
32	L/R	Horizontal shift direction (source output) selection	- 1
33	U/D	Vertical shift direction (gate output) selection	1
34-38	NC	Not connected	
39	LED+	LED anode pin of the backlight	Р
40	LED+	LED anode pin of the backlight	Р

I: Input, O: Output, P: Power

3.1 CTP

NO.	Symbol	Description	I/O
1	GND	Ground	Р
2	NC	Not connected	
3	VDD	Supply voltage	Р
4	SCL	I2C clock input	I
5	SDA	I2C data input and output	I/O
6	INT	External interrupt to the host	I
7	RST	External reset, active low	I
8	GND	Ground	Р



4. LCD Optical Characteristics

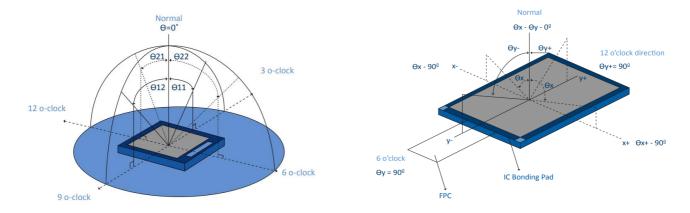
4.1 Optical Specifications

4.1 Optical Sp	ecilications							
Item		Symbol	Condition	Min	Тур.	Max	Unit	Note
Color Gan	nut	S%		45	50		%	(3)
Contrast R	atio	CR		600	800		%	(2)
Response Time	Rising Falling	Tr+Tf			25	40	ms	(4)
	\A/b:+-	W _X	θ=0	0.2477	0.2877	0.3277		
	White	W _Y	Normal viewing	0.2672	0.3072	0.3472		
	Red	R_X		0.5668	0.5868	0.6068		
Color Filter	Red	R _Y	angle	0.3305	0.3505	0.3705		(F)(C)
Chromaticity	Croon	G _X		0.2880	0.3080	0.3280		(5)(6)
	Green	G _Y		0.5230	0.5430	0.5630		
	Dlug	B _X		0.1338	0.1538	0.1738		
	Blue	B _Y		0.0738	0.0938	0.1138		
		ΘL			85			
Minusian Anala	Hor. OR		CR≥10		85		4	(1)(6)
Viewing Angle		ΘТ			85		degrees	(1)(6)
	Ver.	ΘВ			85			
Option View Direction ALL							(1)	



Optical Specification Reference Notes:

(1) Definition of Viewing Angle: The viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3,9 o'clock direction and the vertical or 6/12 o'clock direction with respect to the optical axis which is normal to the LCD surface.

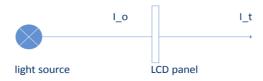


(2) Definition of Contrast Ratio (Cr): measured at the center point of panel. The contrast ratio (Cr) measured on a module, is the ratio between the luminance (Lw) in a full white area (R=G=B=1) and the luminance (Ld) in a dark area (R=G=B=0).

$$Cr = \frac{Lw}{Ld}$$

(3) Definition of transmittance (T%): The transmittance of the panel including the polarizers is measured with electrical driving. The equation for transmittance Tr is:

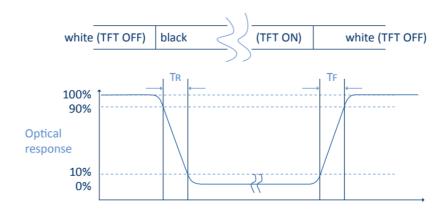
$$Tr = \frac{It}{Io} \times 100\%$$



Io = the brightness of the light source.

It = the brightness after panel transmission

(4) Definition of Response Time (Tr, Tf): The rise time 'Tr' is defined as the time for luminance to change from 90% to 10% as a result of a change of the electrical condition. The fall time 'Tf' is defined as the time for luminance to change from 10% to 90% as a result of a change of the electrical condition.





(5) Definition of Color Gamut:

Measuring machine CFT-01. NTSC's Primaries: R(x,y,Y),G(x,y,Y), B(x,y,Y). FPM520 of Westar Display Technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics. The color chromaticity shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

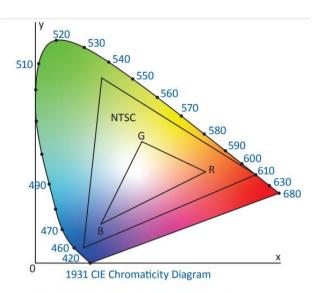
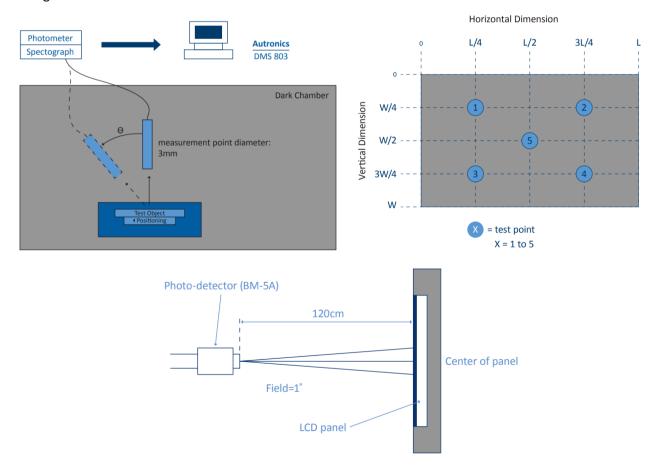


Fig. 1931 CIE chromacity diagram

Color gamut:
$$S = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}} \times 100\%$$

(6) Definition of Optical Measurement Setup:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 20 minutes.





5. TFT Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 °C, VSS=0V)

Characteristics	Symbol	Min	Max	Unit
Digital Supply Voltage	VDD	-0.3	3.6	V
Operating Temperature	ТОР	-20	+70	°C
Storage Temperature	TST	-30	+80	°C

NOTE: If the absolute maximum rating of the above parameters is exceeded, even momentarily, the quality of the product may be degraded. Absolute maximum ratings specify the values which the product may be physically damaged if exceeded. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min	Тур.	Max	Unit	Note
Digital Supply Voltage	VDD	3.0	3.3	3.6	V	
Normal Mode Current	IDD		120	240	mA	
Level Input Voltage	VIH	0.7VDD		VDD	V	
Level imput voltage	VIL	0		0.3VDD	V	
Level Output Voltage	VOH	VDD-0.4			V	
Level Output Voltage	VOL	0		0.4	V	



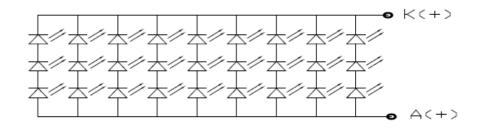
5.3 LED Backlight Characteristics

Item	Symbol	Min	Тур.	Max	Unit	Note
Forward Current	IF	180	270	1	mA	
Forward Voltage	VF		9.6		V	
LCM Luminance	LV	400	450		cd/m2	Note 3
LED lifetime	Hr		50000		hour	Note1 & 2
Uniformity	AVg	80			%	Note 3

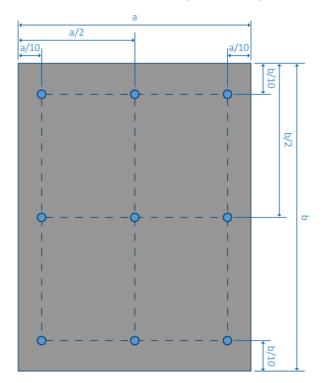
The back-light system is edge-lighting type with 27 chips LED.

Note 1: LED lifetime (Hr) can be defined as the time in which it continues to operate under the condition: $Ta=25 \pm 3$ °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED lifetime" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=270mA. The LED lifetime could be decreased if operating IL is larger than 270mA. The constant current driving method is suggested.



Note 3: Luminance Uniformity of these 9 points is defined as below:



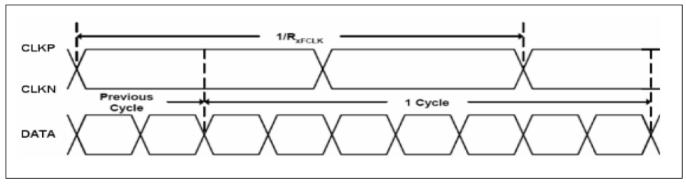


6. Timing Characteristics

6.1 AC Electrical Characteristics

Parameter	Symbol	Min	Тур.	Max	Unit	Note
Clock Frequency	RxFCLK	40.8	51.2	67.2	MHz	
Input data skew margin	Trskm	500			ps	
Clock high time	TLVCH		4/(7*RxFCLK)		ns	
Clock low time	TLVCL		3/(7*RxFCLK)	-1	ns	

6.2 Input Clock and Data Timing Diagram



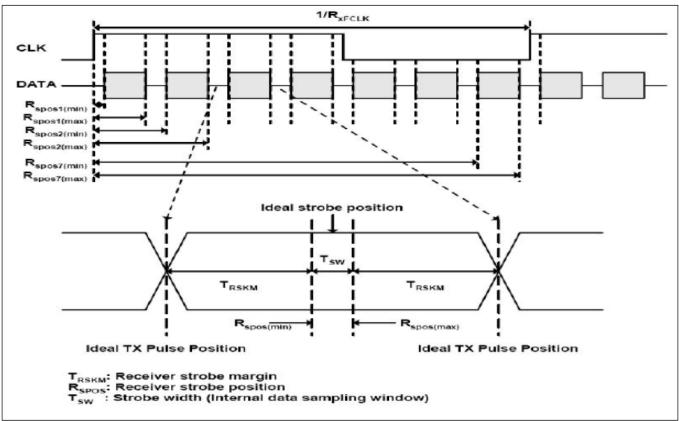


Figure 6.1: Clock and Data Input Diagram



6.3 DC Electrical Characteristics

Parameter	Symbol	Min	Тур.	Max	Unit	Note
Differential Input High Threshold Voltage	RxVтн			+0.1	V	
Differential Input Low Threshold Voltage	RxVTL	-0.1			V	RxVCM=1.2V
Input Voltage Range (single ended)	RxVIN	0		2.4	V	
Differential Input Common Mode Voltage	RxVCM	VID /2	-1	2.4- VID /2	V	
Differential Voltage	VID	0.2	1	0.6	V	
Differential Input Leakage Current	RVxliz	-10		+10	uA	

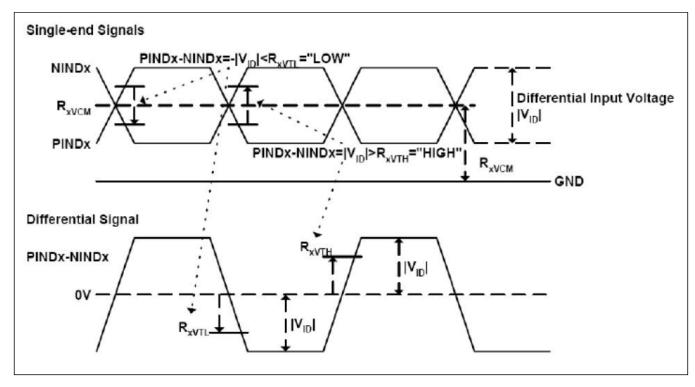


Figure 6.2: Single-End and Differential Signals Diagram

6.4 Horizontal and Vertical Timing Characteristics

Parameter	Symbol	Min	Тур.	Max	Unit	Note
Clock Frequency	fclk	40.8	51.2	67.2	MHz	Frame rate = 60Hz
Horizontal Display Area	thd	1024	1024	1024	DCLK	
HS Period Time	th	1114	1344	1400	DCLK	
HS Blanking	thb	90	320	376	DCLK	
Vertical Display Area	tvd	600	600	600	Н	
VS Period Time	tv	610	635	800	Н	
VS Blanking	thb	10	35	200	Н	



6.5 Data Input Format

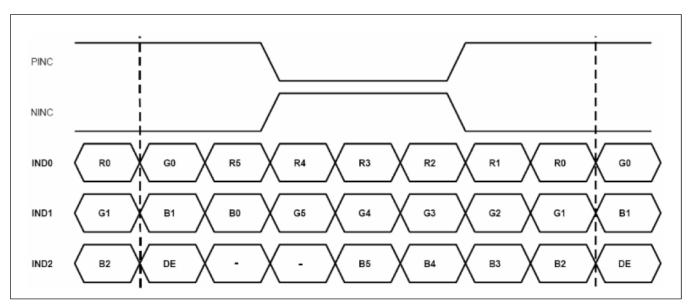


Figure 6:3 6-bit LVDS Input Format Diagram

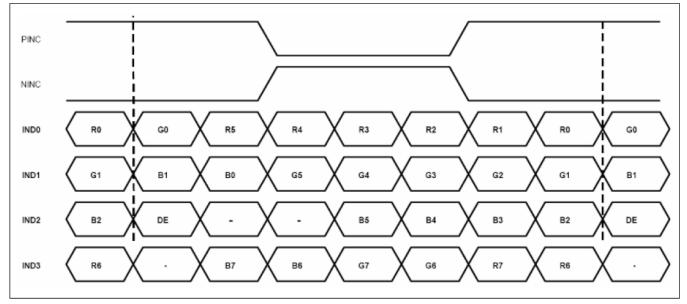


Figure 6.4: 8-bit LVDS Input Format Diagram

Note: Support DE timing mode only. Sync mode is not supported.



7. CTP Specification

7.1 Absolute Maximum Rating

Item	Symbol	Min	Max	Unit	Note
Power Supply Voltage	VDD	2.66	3.47	V	
Operating Temperature	Тор	-20	+70	°C	
Storage Temperature	Тѕт	-30	+80	°C	
Storage Temperature	Тѕт	-30	+80	°C	

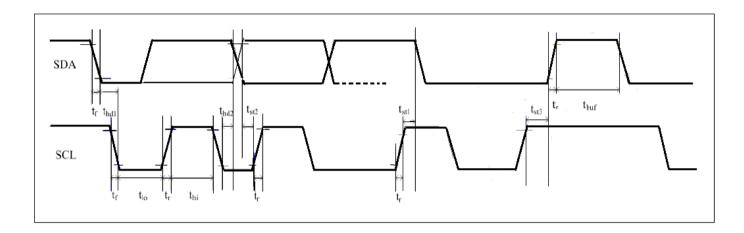
7.2 DC Electrical Characteristics (TA=25°C)

Item	Min	Тур.	Max	Unit	Note
Normal Mode Operating Current		13		mA	
Green Mode Current Consumption		4.5		mA	
Sleep Mode Current Consumption	70		120	uA	
Digital Supply Voltage (VDD)	2.8		3.3	mA	
Digital Input Low Voltage (VIL)	-0.3		0.25VDD	V	
Digital Input High Voltage (VIH)	0.75VDD		VDD+0.3	V	
Digital Output Low Voltage (VOL)			0.15VDD	V	
Digital Output High Voltage (VOH)	0.85VDD			V	



7.3 I2C Interface Characteristics

GT9271 provides a standard I2C interface for SCL and SDA to communicate with the host. GT9271 always serves as slave device in the system with all communication being initialized by the host. It is recommended that transmission rate be kept at or below 400kbps. The figure shown below is the I2C timing:



Parameter	Symbols	Condition	Min	Max	Units
SCL low period	tlo		1.3		us
SCL high period	thi		0.6		us
SCL setup time for start condition	t st1		0.6		us
SCL setup time for stop condition	t st3		0.6		us
SCL hold time for start condition	thd1		0.6		us
SDA setup time	t st2		0.1		us
SDA hold time	thd2		0		us

Table 7.1: I2C AC Characteristics, 1.8V interface voltage, 400kbps transmission rate, 2k pull-up resistor

Parameter	Symbols	Condition	Min	Max	Units
SCL low period	tlo		1.3		us
SCL high period	thi		0.6		us
SCL setup time for start condition	tst1		0.6		us
SCL setup time for stop condition	tst3		0.6		us
SCL hold time for start condition	thd1		0.6		us
SDA setup time	tst2		0.1		us
SDA hold time	thd2		0		us

Table 7.2: I2C AC Characteristics, 3.3V interface voltage, 400kbps transmission rate, 2k pull-up resistor



GT9271 supports two I2C slave addresses: 0xBA/0xBB and 0x28/0x29. The host can select the address by changing the status of Reset and INT pins during the power-on initialization phase. The configuration methods and timings are shown below:

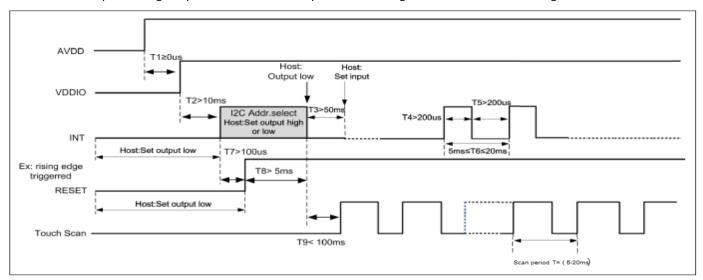


Figure 7.1: I2C Power on Timing

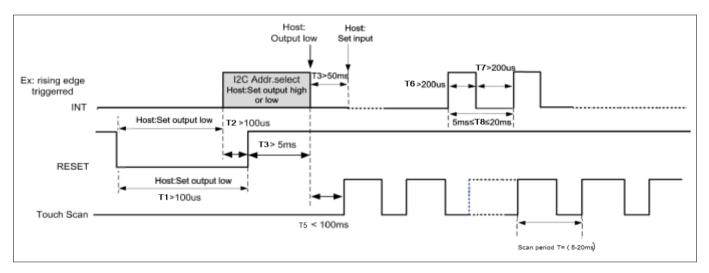


Figure 7.2: I2C Host Resetting Timing

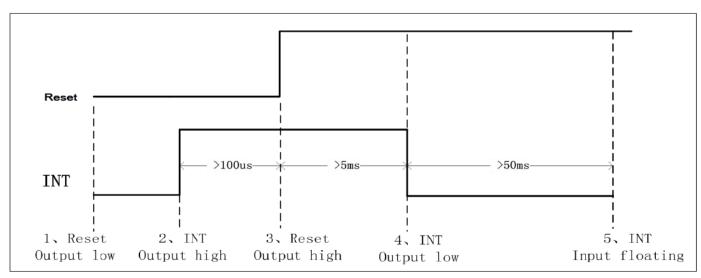


Figure 7.3: Setting Slave Address to 0x28/0x29 Timing



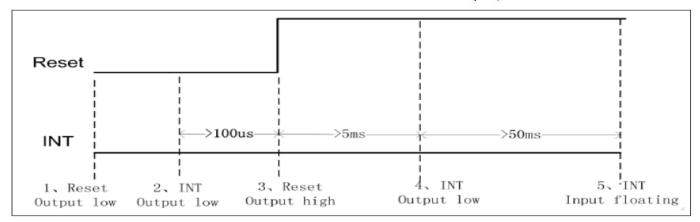


Figure 7.4: Setting Slave Address to 0xBA/0xBB Timing

Data Transmission (ex. 0xBA/0xBB)

Communication is always initiated by the host. Valid start condition is signaled by pulling SDA line from high to low when SCL is high. Data flow or address is transmitted after the start condition.

All slave devices connected to I2C bus should detect the 8-bit address issued after start condition and send the correct ACK. After receiving matching address, GT9271 acknowledges by configuring SDA line as output port and pulling SDA line low during the ninth SCL cycle. When receiving unmatched address, namely not 0xBA or 0xBB, GT9271 will stay in an idle state.

For data bytes on SDA, each of the 9 serial bits will be sent on nine SCL cycles. Each data byte consists of 8 valid data bits and one ACK or NACK bit sent by the recipient. The data transmission is valid when SCL line is high. When communication is completed the host will issue the stop condition. Stop condition implies the transition of SDA line from low to high when SCL is high.

Writing Data to GT9271

The diagram displays the timing sequence of the host writing data onto GT9271. First the host issues a start condition. The host sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates write operation) to the slave device. After receiving ACK, the host sends the 16-bit register address (where writing starts) and the 8-bit data bytes (to be written onto the register)



The location of the register address pointer will automatically add 1 every write operation. When the host needs to perform write operations on a group of registers of continuous addresses it can write continuously. The write operation is terminated when the host issues the stop condition.

Reading Data from GT9271

The diagram below is the timing sequence of the host reading data from GT9271. The host issues the start condition and sends 0xBA (Address bits and R/W bit, R/W bit as 0 indicates write operation) to the slave device. After receiving ACK, the host sends the 16-bit register address (where reading starts) to the slave device. Then the host sets register addresses which need to be read.



The host issues the start condition once again and sends 0xBB (read operation). After receiving ACK, the host starts to read the data. GT9271 also supports continuous read operation. When receiving a byte of data, the host sends an ACK signal indicating successful reception. After receiving the last byte of data, the host sends a NACK signal followed by a STOP condition which terminates communication.



8. Cautions and Handling Precautions

8.1 Handling and Operating the Module

- 1. When the module is assembled, it should be attached to the system firmly. Do not warp or twist the module during assembly work.
- 2. Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- 3. Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- 4. Do not allow drops of water or chemicals to remain on the display surface. If you have the droplets for a long time, staining and discoloration may occur.
- 5. If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- 6. The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane. Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- 7. If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- 8. Protect the module from static; it may cause damage to the CMOS ICs.
- 9. Use fingerstalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- 10. Do not disassemble the module.
- 11. Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- 12. Pins of I/F connector shall not be touched directly with bare hands.
- 13. Do not connect, disconnect the module in the "Power ON" condition.
- 14. Power supply should always be turned on/off by the item Power On Sequence & Power Off Sequence.

8.2 Storage and Transportation.

- 1. Do not leave the panel in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- 2. Do not store the TFT-LCD module in direct sunlight.
- 3. The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- 4. It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module. In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- 5. This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.